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FDP083N15A N-Channel PowerTrench[®] MOSFET 150 V, 117 A, 8.3 mΩ

Features

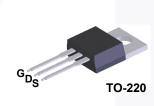
- $R_{DS(on)}$ = 6.85 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 75 A
- · Fast Switching Speed
- Low Gate Charge, Q_G = 64.5 nC (Typ.)
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

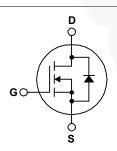
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Micro Solar Inverter





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FDP083N15A_F102	Unit V		
V _{DSS}	Drain to Source Voltage	150			
V _{GSS}	Gate to Source Voltage	- DC	±20	V	
	Gale to Source voltage	- AC (f > 1 Hz)	±30		
I _D	Drain Current	- Continuous (T _C = 25 ^o C, Silicon Limited)	117	- A	
	Drain Current	- Continuous (T _C = 100 ^o C, Silicon Limited)	83		
I _{DM}	Drain Current	- Pulsed (Note 1)	468	Α	
E _{AS}	Single Pulsed Avalanche Er	542	mJ		
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6	V/ns	
P _D	Dower Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$	294	W	
	Power Dissipation	- Derate Above 25°C	1.96	W/ºC	
T _J , T _{STG}	Operating and Storage Tem	-55 to +175	°C		
TL	Maximum Lead Temperatur	300	°C		

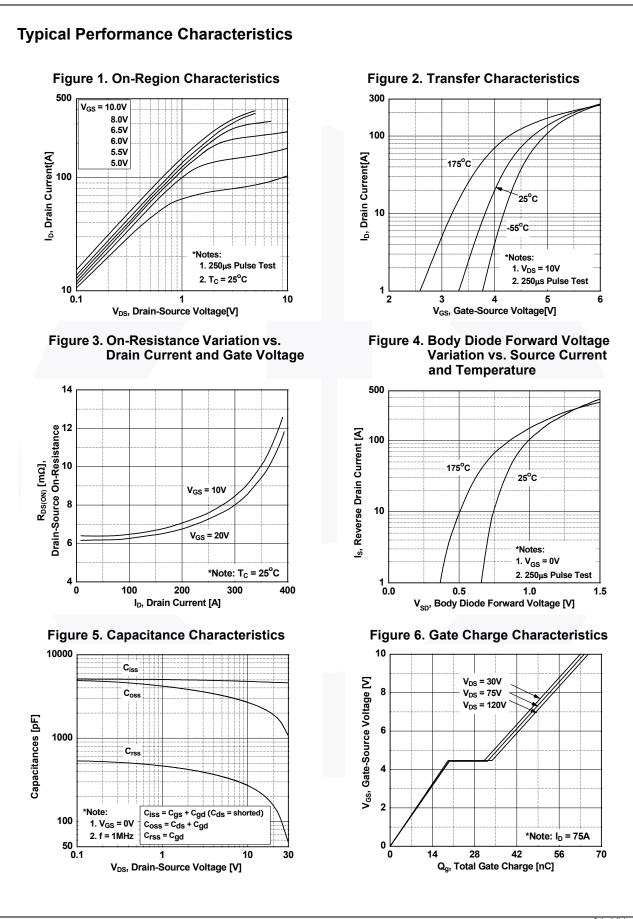
Thermal Characteristics

Symbol	Parameter	FDP083N15A_F102	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.51	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W

April 2015

Part Number		Top Mark	Package			Тар	e Width	Qua	ntity
FDP083N15			TO-220				N/A	50 units	
Electrical	Chara	acteristics T_c =	= 25ºC unless	otherwise noted.		·			
Symbol	Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Charact	teristics	; ;							
BV _{DSS}	Drain to Source Breakdown Voltage			I _D = 250 μA, V _{GS} = 0 V, T _C = 25 ^o C			-	-	V
ΔBV _{DSS} / ΔTJ	Breakdown Voltage Temperature Coefficient		-	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-	0.08	-	V/ºC
				V _{DS} = 120 V, V _{GS} = 0 V		-	-	- 1	
DSS	Zero Gate Voltage Drain Current		ent	$V_{DS} = 120 \text{ V}, V_{GS} = 0.0 \text{ V}$ $V_{DS} = 120 \text{ V}, T_{C} = 150^{\circ}\text{C}$			-	500	μA
GSS	Gate to Body Leakage Current			$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			-	±100	nA
On Charact	teristics								
V _{GS(th)}	Gate Threshold Voltage			V _{GS} = V _{DS} , I _D = 250 μ	A	2.0	_	4.0	V
VGS(th) R _{DS(on)}	Static Drain to Source On Resistance		sistance	$V_{GS} = V_{DS}, I_D = 250 \mu A$ $V_{GS} = 10 V, I_D = 75 A$		-	6.85	8.30	mΩ
9 _{FS}	Forward Transconductance			$V_{GS} = 10 \text{ V}, I_D = 75 \text{ A}$ $V_{DS} = 10 \text{ V}, I_D = 75 \text{ A}$			139	-	S
									Ū
Dynamic C	haracte	ristics							
C _{iss}	Input Ca	pacitance		1/2 = 25 1/1/2 = 0	/	-	4645	6040	pF
C _{oss}	Output C	Capacitance		− V _{DS} = 25 V, V _{GS} = 0 \ _ f = 1 MHz	ν,	-	1445	1880	pF
C _{rss}	Reverse	Transfer Capacitance	е			-	100	-	pF
C _{iss}	Input Ca	Input Capacitance				-	4570	6040	pF
C _{oss}	Output C	apacitance		− V _{DS} = 7 5V, V _{GS} = 0 \ _ f = 1 MHz	ν,		460	1880	pF
C _{rss}	Reverse	Transfer Capacitance	е			-	20	-	pF
Q _{g(tot)}	Total Gat	te Charge at 10V				-	64.5	84	nC
Q _{gs}	Gate to S	Source Gate Charge		V _{DS} = 120 V, I _D = 75 /	A,	-	19.1	-	nC
Q _{gs2}	Gate Cha	arge Threshold to Pla	ateau	V _{GS} = 10 V		-	8.7	-	nC
Q _{gd}	Gate to D	Drain "Miller" Charge			(Note 4)	-	13.5	-	nC
ESR	Equivale	nt Series Resistance	(G-S)	f = 1 MHz		-	2.5	-	Ω
Switching (Charact	eristics							
t _{d(on)}		Delay Time		$V_{DD} = 75 \text{ V}, \text{ I}_{D} = 75 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$ (Note 4)			22	54	ns
t _r		Rise Time				-	58	126	ns
t _{d(off)}		Delay Time					61	132	ns
t _f		Fall Time				-	26	62	ns
Jrain-Sour		e Characteristic					1		1 -
s				de Forward Current		-	-	117	A
I _{SM}		n Pulsed Drain to Sou		F		-	-	468	A
V _{SD}		ain to Source Diode Forward Voltage		V _{GS} = 0 V, I _{SD} = 75 A		-	-	1.25	V
t _{rr}		Recovery Time		$V_{GS} = 0 V, I_{SD} = 75 A,$		-	96		ns
Q _{rr}	Reverse	Recovery Charge		dI _F /dt = 100 A/µs		-	268		nC

FDP083N15A — N-Channel PowerTrench[®] MOSFET





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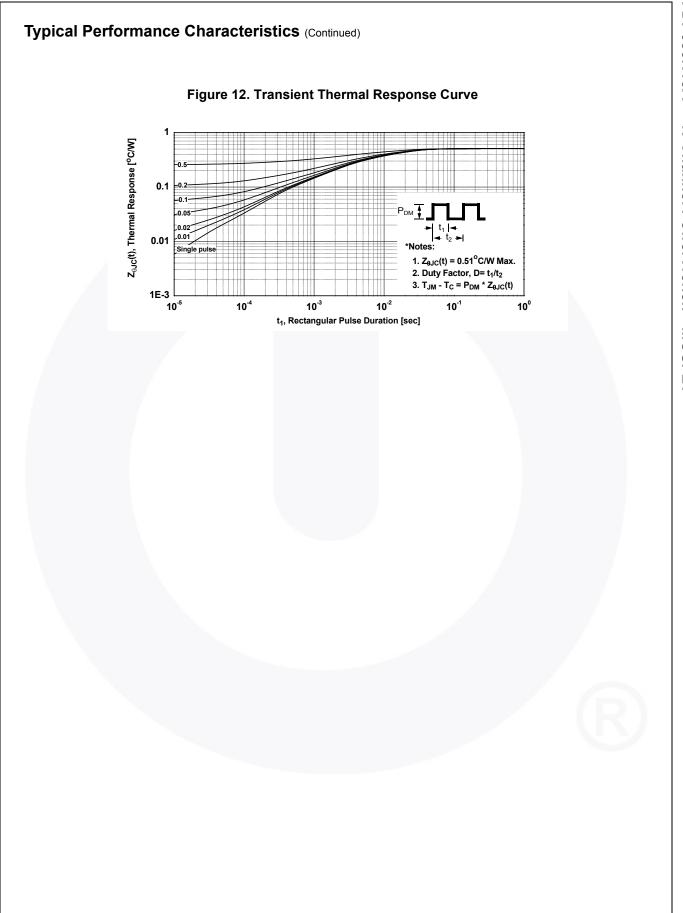
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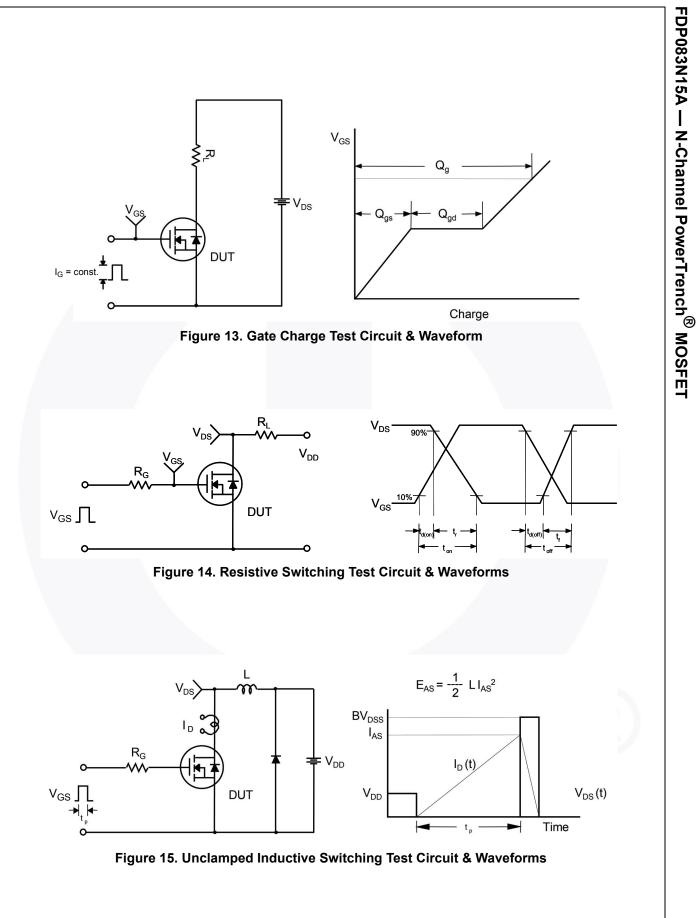
Typical Performance Characteristics (Continued) Figure 7. Breakdown Voltage Variation Figure 8. On-Resistance Variation vs. Temperature vs. Temperature 1.10 3.0 R_{DS(on)}, [Nonuce Drain-Source On-Resistance 1 75 55 Drain-Source Breakdown Voltage 1.05 **BV_{DSS}**, [Normalized] 1.00 0.95 *Notes: *Notes: 1. V_{GS} = 0V 1. V_{GS} = 10V 2. I_D = 250μA 2. I_D = 75A 0.90 └ -100 0.0 -50 0 50 100 150 200 -100 -50 100 150 0 50 T_J, Junction Temperature [°C] T_J, Junction Temperature [°C] Figure 9. Maximum Safe Operating Area Figure 10. Maximum Drain Current vs. Case Temperature 1000 120 100 100 10µs I_D, Drain Current [A] I_b, Drain Current [A] 80 100µs 10 V_{GS} = 10V 60 1ms **Operation in This Area** X is Limited by R DS(on) 1 10ms 40 SINGLE PULSE DC $T_C = 25^{\circ}C$ 0.1 20 T_J = 175^oC $R_{\theta JC} = 0.51^{\circ}C/W$ $R_{\theta JC}$ = 0.51°C/W 0.01 0 1 10 V_{DS}, Drain-Source Voltage [V] 0 75 100 125 T_C, Case Temperature [°C] 100 300 0.1 25 50 Figure 11. Unclamped Inductive Switching Capability 300 If R $t_{AV} = (L)(I_{AS})/(1.3*RATED BV_{DSS}-V_{DD})$ If R = 0 I_{AS}, AVALANCHE CURRENT (A) 100 $t_{AV} = (L/R) ln [(las*R)/(1)]$ 3*PATED BV STARTING T 10 STARTING T = 150°C 0.001 0.01 0.1 100 1000 10 1 t_{AV}, TIME IN AVALANCHE (ms)

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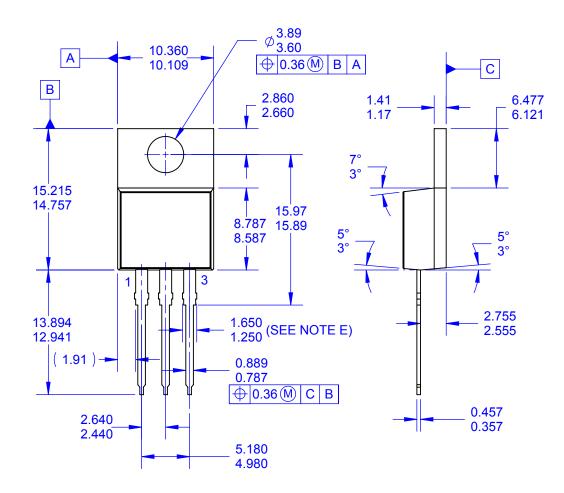


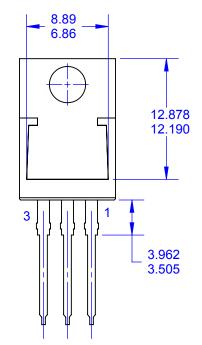
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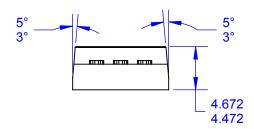


DUT + V_{DS} a ۱_{SD} م L Driver R_G, Same Type as DUT L F V_{DD} $\prod V_{GS}$ • dv/dt controlled by R_G • I_{SD} controlled by pulse period Î Gate Pulse Width $\mathbf{V}_{\mathbf{GS}}$ D = Gate Pulse Period 10V (Driver) I_{FM}, Body Diode Forward Current I _{SD} di/dt (DUT) I_{RM} Body Diode Reverse Current V_{DS} (DUT) Body Diode Recovery dv/dt V_{SD} V_{DD} Body Diode Forward Voltage Drop Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

FDP083N15A — N-Channel PowerTrench[®] MOSFET







NOTES:

- A. PACKAGE REFERENCE: JEDEC TO220 VARIATION AB
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS,
 - MOLD FLASH AND TIE BAR PROTRUSIÓNS.
- E. MAX WIDTH FOR F102 DEVICE = 1.35mm. F. DRAWING FILE NAME: TO220T03REV4.
- G. FAIRCHILD SEMICONDUCTOR.

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